

ZTX1049A

NPN SILICON PLANAR MEDIUM POWER HIGH GAIN TRANSISTOR

FEATURES

- $V_{CEV} = 80V$
- Very low saturation voltages
- High gain
- 20 amps pulse current

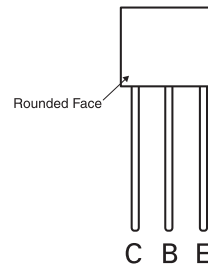
APPLICATIONS

- LCD backlight converters
- Emergency lighting
- DC-DC converters



E-Line

PINOUT



SIDE VIEW

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	VALUE	UNIT
Collector-Base Voltage	V_{CBO}	80	V
Collector-Emitter Voltage	V_{CEO}	25	V
Emitter-Base Voltage	V_{EBO}	5	V
Peak Pulse Current	I_{CM}	20	A
Continuous Collector Current	I_C	4	A
Base Current	I_B	500	mA
Power Dissipation at $T_{amb}=25^{\circ}C$	P_{tot}	1	W
Operating and Storage Temperature Range	$T_j; T_{stg}$	-55 to +200	$^{\circ}C$

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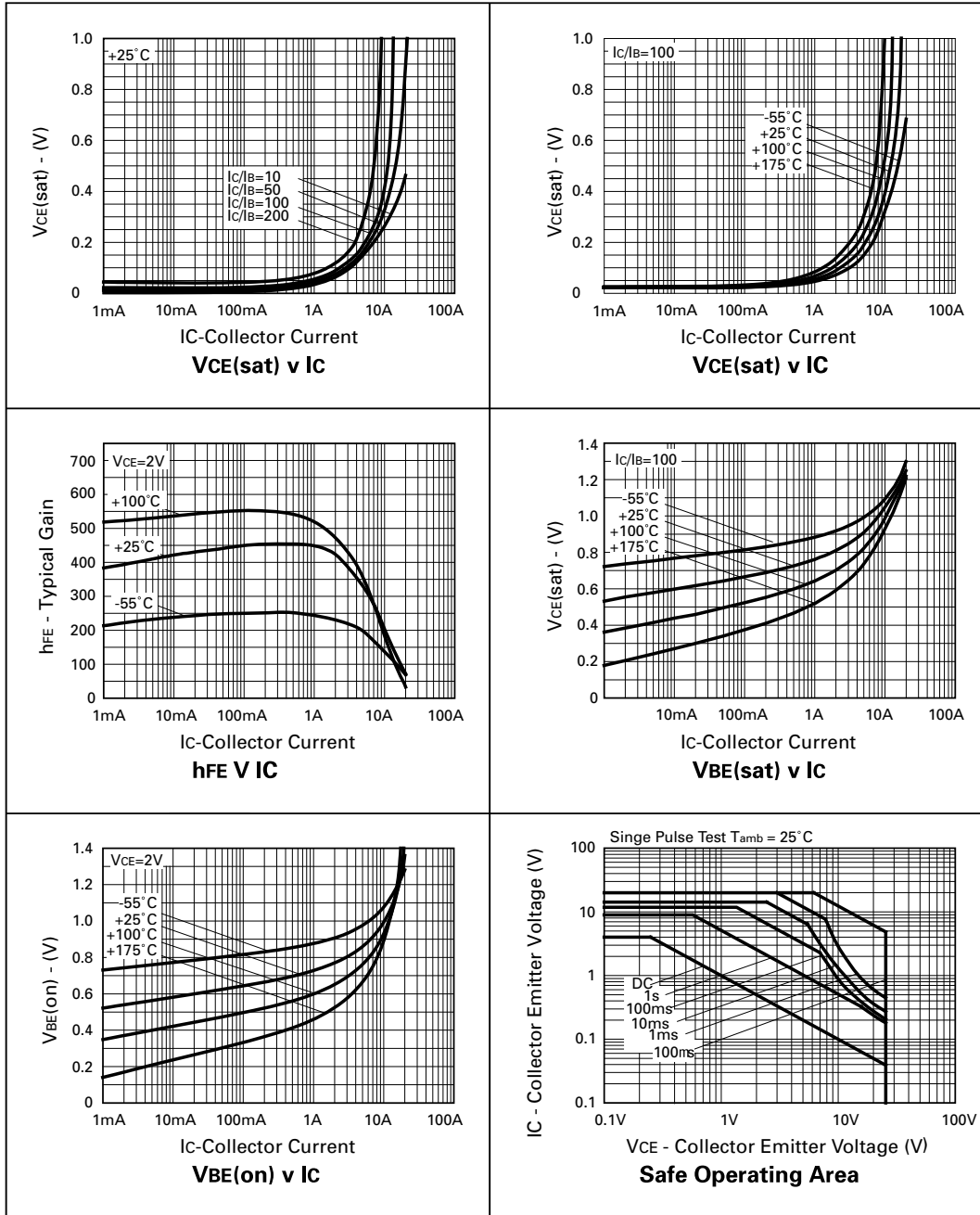
ELECTRICAL CHARACTERISTICS (at $T_{amb} = 25^{\circ}\text{C}$ unless otherwise stated).

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS
Collector-Base Breakdown Voltage	$V_{(BR)CBO}$	80	120		V	$I_C=100\mu\text{A}$
Collector-Emitter Breakdown Voltage	V_{CES}	80	120		V	$I_C=100\mu\text{A}$
Collector-Emitter Breakdown Voltage	V_{CEO}	25	30		V	$I_C=10\text{mA}$
Collector-Emitter Breakdown Voltage	V_{CEV}	80	120		V	$I_C=100\mu\text{A}, V_{EB}=1\text{V}$
Emitter-Base Breakdown Voltage	$V_{(BR)EBO}$	5	8.75		V	$I_E=100\mu\text{A}$
Collector Cut-Off Current	I_{CBO}		0.3	10	nA	$V_{CB}=50\text{V}$
Emitter Cut-Off Current	I_{EBO}		0.3	10	nA	$V_{EB}=4\text{V}$
Collector Emitter Cut-Off Current	I_{CES}		0.3	10	nA	$V_{CES}=50\text{V}$
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$		30 60 125 155	45 80 180 220	mV mV mV mV	$I_C=0.5\text{A}, I_B=10\text{mA}^*$ $I_C=1\text{A}, I_B=10\text{mA}^*$ $I_C=2\text{A}, I_B=10\text{mA}^*$ $I_C=4\text{A}, I_B=50\text{mA}^*$
Base-Emitter Saturation Voltage	$V_{BE(sat)}$		890	950	mV	$I_C=4\text{A}, I_B=50\text{mA}^*$
Base-Emitter Turn-On Voltage	$V_{BE(on)}$		820	900	mV	$I_C=4\text{A}, V_{CE}=2\text{V}^*$
Static Forward Current Transfer Ratio	h_{FE}	250 300 300 200 35	430 450 450 350 70	1200		$I_C=10\text{mA}, V_{CE}=2\text{V}^*$ $I_C=0.5\text{A}, V_{CE}=2\text{V}^*$ $I_C=1\text{A}, V_{CE}=2\text{V}^*$ $I_C=4\text{A}, V_{CE}=2\text{V}^*$ $I_C=20\text{A}, V_{CE}=2\text{V}^*$
Transition Frequency	f_T		180		MHz	$I_C=50\text{mA}, V_{CE}=10\text{V}$ $f=50\text{MHz}$
Output Capacitance	C_{obo}		45	60	pF	$V_{CB}=10\text{V}, f=1\text{MHz}$
Turn - On Time	t_{on}		125		ns	$I_C=4\text{A}, I_B=40\text{mA}, V_{CC}=10\text{V}$
Turn - Off Time	t_{off}		380		ns	$I_C=4\text{A}, I_B=\pm 40\text{mA}, V_{CC}=10\text{V}$

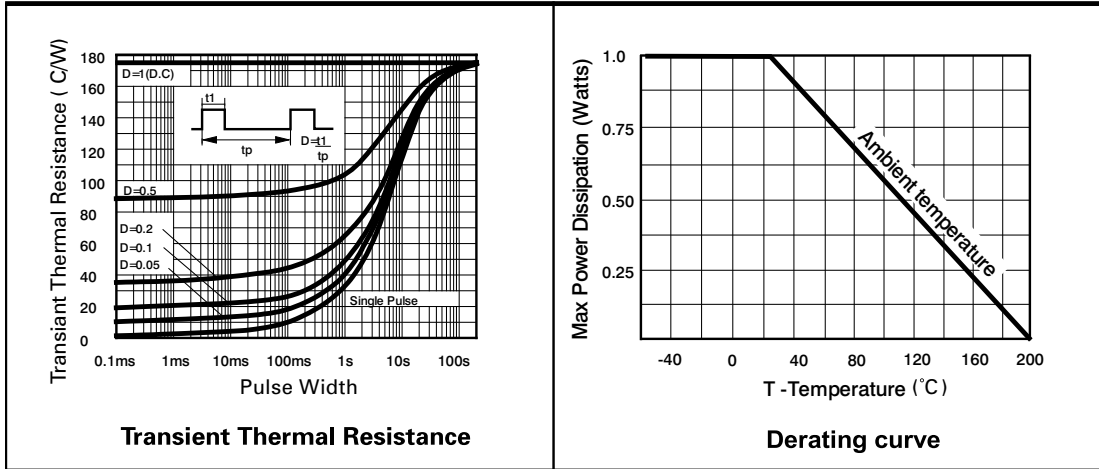
*Measured under pulsed conditions. Pulse width=300 μs . Duty cycle $\leq 2\%$

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TYPICAL CHARACTERISTICS



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SPICE PARAMETERS

*ZETEX ZTX1049A Spice model v1.0 Last revision 10/1/97

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.MODEL ZTX1149A PNP IS=9.5e-13 NF=1.002 ISE=1.2e-13 NE=1.4 BF=520

+ VAF=24.97 IKF=5 NR=0.997 ISC=4.5E-13 NC=1.25 BR=40

+ VAR=2.51 IKR=0.7 RE=20e-3 RB=150e-3 RC=10e-3

+ CJE=490e-12 CJC=150e-12 VJC=1.094 MJC=0.4739

+ TF=1e-9 TR=3.5e-9

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Datasheet status key:

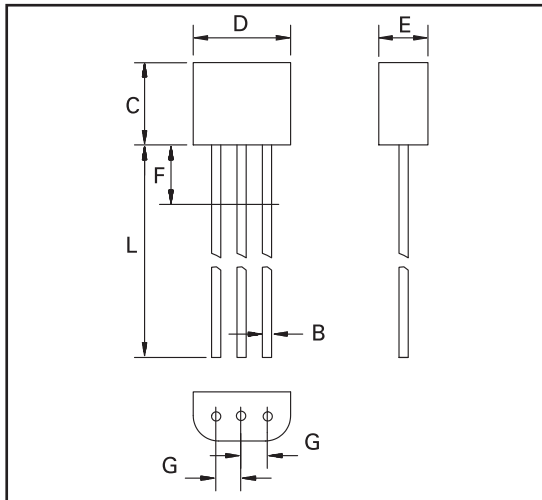
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PACKAGE OUTLINE



Controlling dimensions are in millimeters. Approximate conversions are given in inches

PACKAGE DIMENSIONS

DIM	Millimeters		Inches	
	Min	Max	Min	Max
A	0.41	0.495	0.016	0.0195
B	0.41	0.495	0.016	0.0195
C	3.61	4.01	0.142	0.158
D	4.37	4.77	0.172	0.188
E	2.16	2.41	0.085	0.095
F	—	2.50	—	0.098
G	1.27 NOM		0.050 NOM	
L	13.00	13.97	0.512	0.550

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